

**GenX3™ 1200V  
IGBTs**
**IXGK82N120A3  
IXGX82N120A3**

$$V_{CES} = 1200V$$

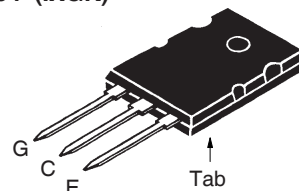
$$I_{C110} = 82A$$

$$V_{CE(sat)} \leq 2.05V$$

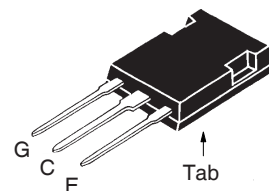
 Ultra-Low-V<sub>sat</sub> PT IGBTs for  
up to 3kHz Switching


| Symbol                        | Test Conditions                                                                     | Maximum Ratings                         |            |
|-------------------------------|-------------------------------------------------------------------------------------|-----------------------------------------|------------|
| $V_{CES}$                     | $T_J = 25^\circ C$ to $150^\circ C$                                                 | 1200                                    | V          |
| $V_{CGR}$                     | $T_J = 25^\circ C$ to $150^\circ C$ , $R_{GE} = 1M\Omega$                           | 1200                                    | V          |
| $V_{GES}$                     | Continuous                                                                          | $\pm 20$                                | V          |
| $V_{GEM}$                     | Transient                                                                           | $\pm 30$                                | V          |
| $I_{C25}$                     | $T_C = 25^\circ C$ ( Chip Capability )                                              | 260                                     | A          |
| $I_{C110}$                    | $T_C = 110^\circ C$                                                                 | 82                                      | A          |
| $I_{LRMS}$                    | $T_C = 25^\circ C$ (Lead RMS Limit)                                                 | 120                                     | A          |
| $I_{CM}$                      | $T_C = 25^\circ C$ , 1ms                                                            | 580                                     | A          |
| <b>SSOA</b><br><b>(RBSOA)</b> | $V_{GE} = 15V$ , $T_{VJ} = 125^\circ C$ , $R_G = 2\Omega$<br>Clamped Inductive Load | $I_{CM} = 164$<br>@ $0.8 \cdot V_{CES}$ | A          |
| $P_C$                         | $T_C = 25^\circ C$                                                                  | 1250                                    | W          |
| $T_J$                         |                                                                                     | -55 ... +150                            | $^\circ C$ |
| $T_{JM}$                      |                                                                                     | 150                                     | $^\circ C$ |
| $T_{stg}$                     |                                                                                     | -55 ... +150                            | $^\circ C$ |
| $T_L$                         | Maximum Lead Temperature for Soldering                                              | 300                                     | $^\circ C$ |
| $T_{SOLD}$                    | 1.6 mm (0.062 in.) from Case for 10                                                 | 260                                     | $^\circ C$ |
| $M_d$                         | Mounting Torque ( IXGK )                                                            | 1.13/10                                 | Nm/lb.in.  |
| $F_C$                         | Mounting Force ( IXGX )                                                             | 20..120/4.5..27                         | N/lb.      |
| <b>Weight</b>                 | TO-264                                                                              | 10                                      | g          |
|                               | PLUS247                                                                             | 6                                       | g          |

TO-264 (IXGK)



PLUS247™ (IXGX)



G = Gate                      E = Emitter  
C = Collector                Tab = Collector

**Features**

- Optimized for Low Conduction Losses
- International Standard Packages

**Advantages**

- High Power Density
- Low Gate Drive Requirement

**Applications**

- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts
- Inrush Current Protection Circuits

| Symbol        | Test Conditions<br>( $T_J = 25^\circ C$ , Unless Otherwise Specified) | Characteristic Values |              |                      |
|---------------|-----------------------------------------------------------------------|-----------------------|--------------|----------------------|
|               |                                                                       | Min.                  | Typ.         | Max.                 |
| $BV_{CES}$    | $I_C = 250\mu A$ , $V_{CE} = 0V$                                      | 1200                  |              | V                    |
| $V_{GE(th)}$  | $I_C = 1mA$ , $V_{CE} = V_{GE}$                                       | 3.0                   |              | 5.0 V                |
| $I_{CES}$     | $V_{CE} = V_{CES}$ , $V_{GE} = 0V$<br>Note 1, $T_J = 125^\circ C$     |                       |              | 50 $\mu A$<br>2.5 mA |
| $I_{GES}$     | $V_{CE} = 0V$ , $V_{GE} = \pm 20V$                                    |                       |              | $\pm 100$ nA         |
| $V_{CE(sat)}$ | $I_C = I_{C110}$ , $V_{GE} = 15V$ , Note 2<br>$T_J = 125^\circ C$     |                       | 1.83<br>1.95 | 2.05 V               |

| Symbol       | Test Conditions<br>( $T_J = 25^\circ\text{C}$ , Unless Otherwise Specified) | Characteristic Values                          |      |                    |
|--------------|-----------------------------------------------------------------------------|------------------------------------------------|------|--------------------|
|              |                                                                             | Min.                                           | Typ. | Max.               |
| $g_{fs}$     | $I_C = 60\text{A}$ , $V_{CE} = 10\text{V}$ , Note 2                         | 40                                             | 66   | S                  |
| $C_{ies}$    | $V_{CE} = 25\text{V}$ , $V_{GE} = 0\text{V}$ , $f = 1\text{MHz}$            |                                                | 7700 | pF                 |
| $C_{oes}$    |                                                                             |                                                | 520  | pF                 |
| $C_{res}$    |                                                                             |                                                | 190  | pF                 |
| $Q_{g(on)}$  | $I_C = I_{C110}$ , $V_{GE} = 15\text{V}$ , $V_{CE} = 0.5 \cdot V_{CES}$     |                                                | 340  | nC                 |
| $Q_{ge}$     |                                                                             |                                                | 54   | nC                 |
| $Q_{gc}$     |                                                                             |                                                | 146  | nC                 |
| $t_{d(on)}$  | Inductive load, $T_J = 25^\circ\text{C}$                                    |                                                | 34   | ns                 |
| $t_{ri}$     |                                                                             |                                                | 75   | ns                 |
| $E_{on}$     |                                                                             | $I_C = 80\text{A}$ , $V_{GE} = 15\text{V}$     | 5.5  | mJ                 |
| $t_{d(off)}$ | Note 3                                                                      | $V_{CE} = 0.5 \cdot V_{CES}$ , $R_G = 2\Omega$ | 265  | ns                 |
| $t_{fi}$     |                                                                             |                                                | 780  | 1300 ns            |
| $E_{off}$    |                                                                             |                                                | 12.5 | 20.0 mJ            |
| $t_{d(on)}$  | Inductive load, $T_J = 125^\circ\text{C}$                                   |                                                | 32   | ns                 |
| $t_{ri}$     |                                                                             |                                                | 77   | ns                 |
| $E_{on}$     |                                                                             | $I_C = 80\text{A}$ , $V_{GE} = 15\text{V}$     | 6.7  | mJ                 |
| $t_{d(off)}$ | Note 3                                                                      | $V_{CE} = 0.5 \cdot V_{CES}$ , $R_G = 2\Omega$ | 340  | ns                 |
| $t_{fi}$     |                                                                             |                                                | 1250 | ns                 |
| $E_{off}$    |                                                                             |                                                | 22.5 | mJ                 |
| $R_{thJC}$   |                                                                             |                                                | 0.10 | $^\circ\text{C/W}$ |
| $R_{thCK}$   |                                                                             |                                                | 0.15 | $^\circ\text{C/W}$ |

**Notes:**

1. Part must be heatsunk for high-temp  $I_{CES}$  measurement.
2. Pulse test,  $t \leq 300\mu\text{s}$ , duty cycle,  $d \leq 2\%$ .
3. Switching times & energy losses may increase for higher  $V_{CE}(\text{Clamp})$ ,  $T_J$  or  $R_G$ .

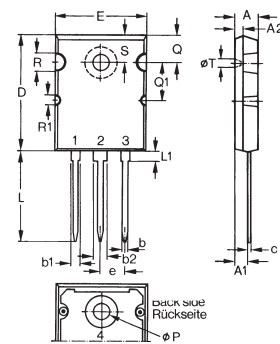
### PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

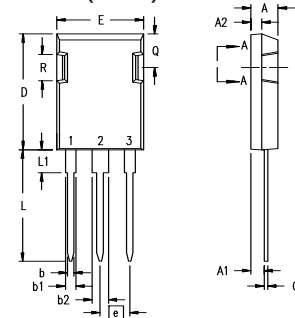
|                                                                                  |           |           |           |           |              |              |              |              |              |             |
|----------------------------------------------------------------------------------|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|--------------|-------------|
| IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665    | 6,404,065 B1 | 6,683,344    | 6,727,585    | 7,005,734 B2 | 7,157,338B2 |
|                                                                                  | 4,850,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343    | 6,710,405 B2 | 6,759,692    | 7,063,975 B2 |             |
|                                                                                  | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505    | 6,710,463    | 6,771,478 B2 | 7,071,537    |             |

### TO-264 AA (IXGK) Outline



| Dim. | Millimeter |       | Inches   |       |
|------|------------|-------|----------|-------|
|      | Min.       | Max.  | Min.     | Max.  |
| A    | 4.82       | 5.13  | .190     | .202  |
| A1   | 2.54       | 2.89  | .100     | .114  |
| A2   | 2.00       | 2.10  | .079     | .083  |
| b    | 1.12       | 1.42  | .044     | .056  |
| b1   | 2.39       | 2.69  | .094     | .106  |
| b2   | 2.90       | 3.09  | .114     | .122  |
| c    | 0.53       | 0.83  | .021     | .033  |
| D    | 25.91      | 26.16 | 1.020    | 1.030 |
| E    | 19.81      | 19.96 | .780     | .786  |
| e    | 5.46 BSC   |       | .215 BSC |       |
| J    | 0.00       | 0.25  | .000     | .010  |
| K    | 0.00       | 0.25  | .000     | .010  |
| L    | 20.32      | 20.83 | .800     | .820  |
| L1   | 2.29       | 2.59  | .090     | .102  |
| P    | 3.17       | 3.66  | .125     | .144  |
| Q    | 6.07       | 6.27  | .239     | .247  |
| Q1   | 8.38       | 8.69  | .330     | .342  |
| R    | 3.81       | 4.32  | .150     | .170  |
| R1   | 1.78       | 2.29  | .070     | .090  |
| S    | 6.04       | 6.30  | .238     | .248  |
| T    | 1.57       | 1.83  | .062     | .072  |

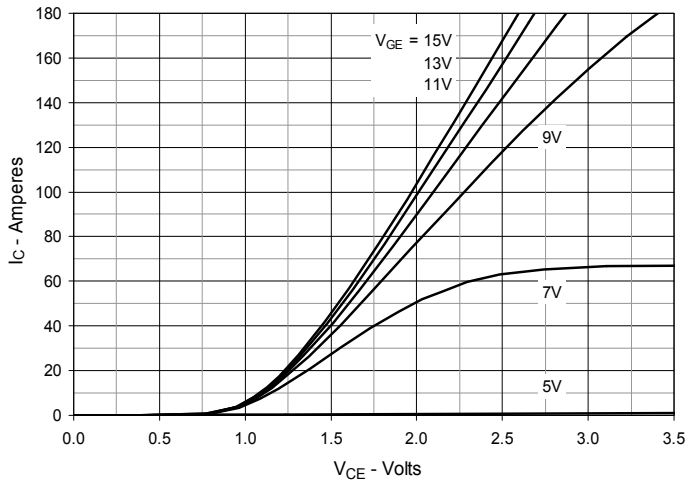
### PLUS247™ (IXGX) Outline



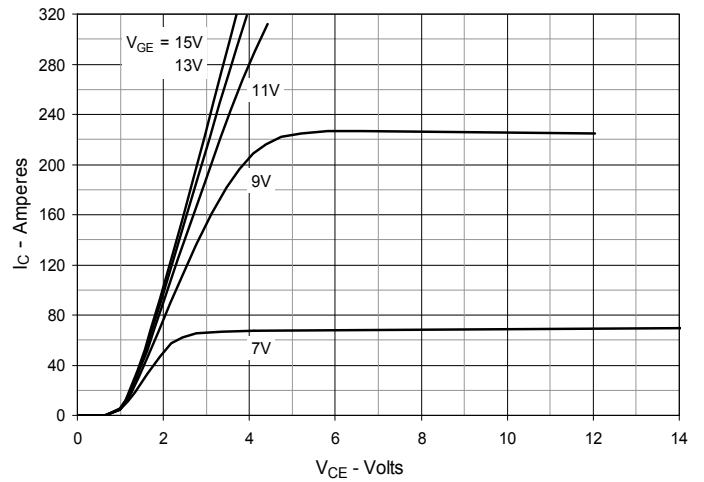
Terminals: 1 - Gate  
2 - Drain (Collector)  
3 - Source (Emitter)

| Dim.           | Millimeter |       | Inches   |       |
|----------------|------------|-------|----------|-------|
|                | Min.       | Max.  | Min.     | Max.  |
| A              | 4.83       | 5.21  | .190     | .205  |
| A <sub>1</sub> | 2.29       | 2.54  | .090     | .100  |
| A <sub>2</sub> | 1.91       | 2.16  | .075     | .085  |
| b              | 1.14       | 1.40  | .045     | .055  |
| b <sub>1</sub> | 1.91       | 2.13  | .075     | .084  |
| b <sub>2</sub> | 2.92       | 3.12  | .115     | .123  |
| C              | 0.61       | 0.80  | .024     | .031  |
| D              | 20.80      | 21.34 | .819     | .840  |
| E              | 15.75      | 16.13 | .620     | .635  |
| e              | 5.45 BSC   |       | .215 BSC |       |
| L              | 19.81      | 20.32 | .780     | .800  |
| L1             | 3.81       | 4.32  | .150     | .170  |
| Q              | 5.59       | 6.20  | .220     | 0.244 |
| R              | 4.32       | 4.83  | .170     | .190  |

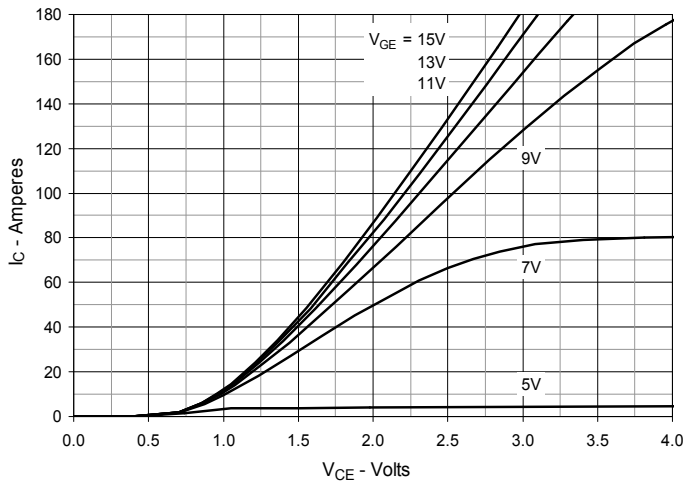
**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$**



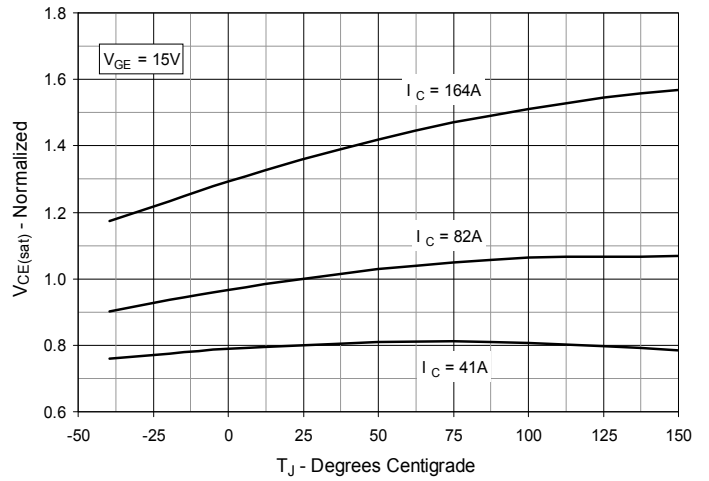
**Fig. 2. Extended Output Characteristics @  $T_J = 25^\circ\text{C}$**



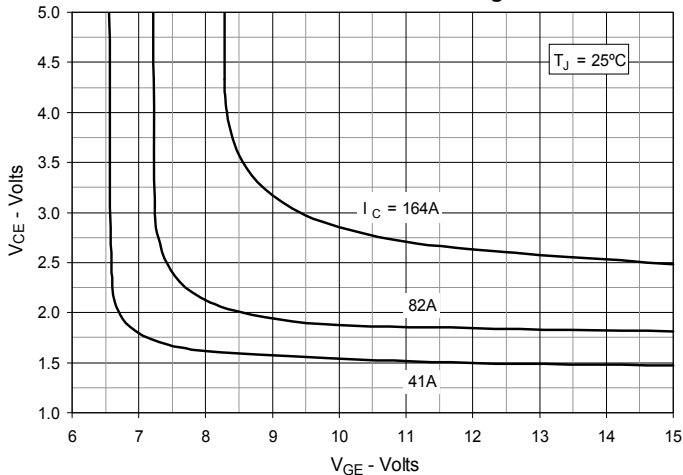
**Fig. 3. Output Characteristics @  $T_J = 125^\circ\text{C}$**



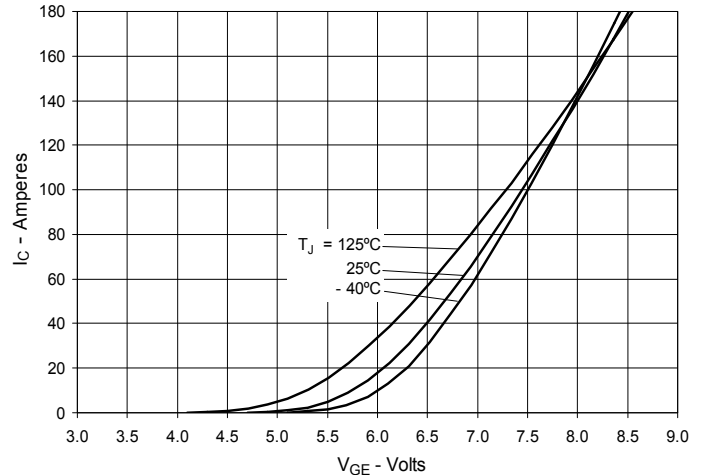
**Fig. 4. Dependence of  $V_{CE(sat)}$  on Junction Temperature**



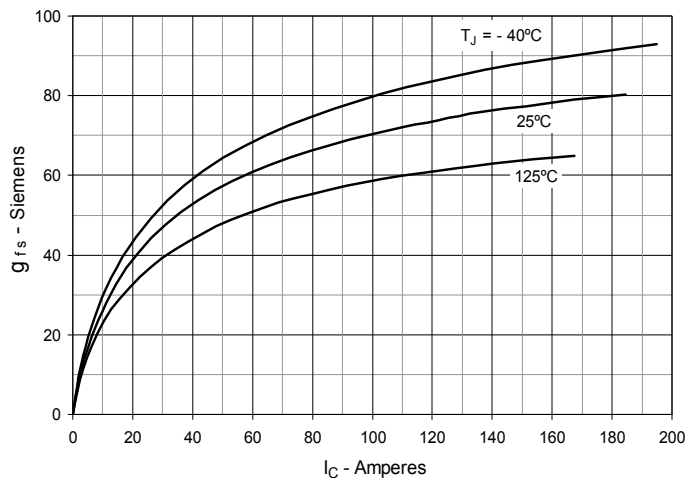
**Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage**



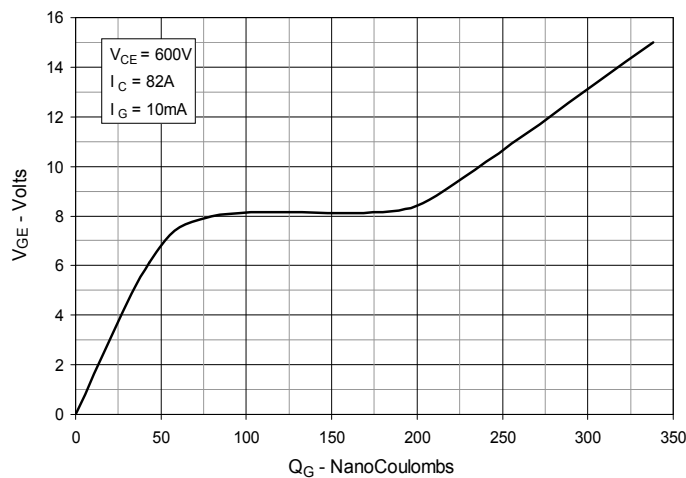
**Fig. 6. Input Admittance**



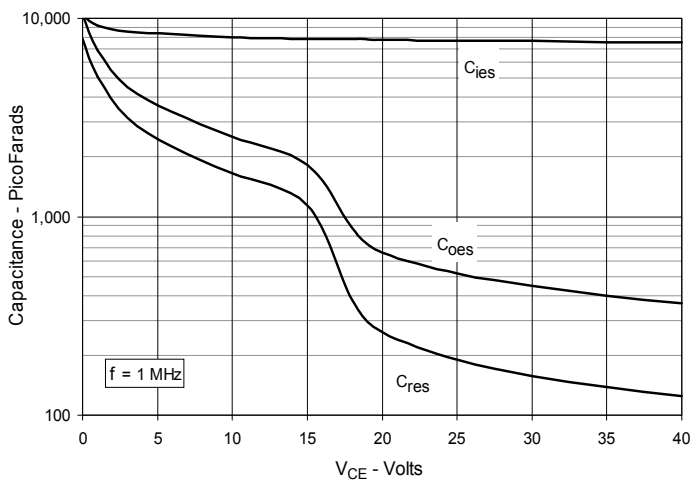
**Fig. 7. Transconductance**



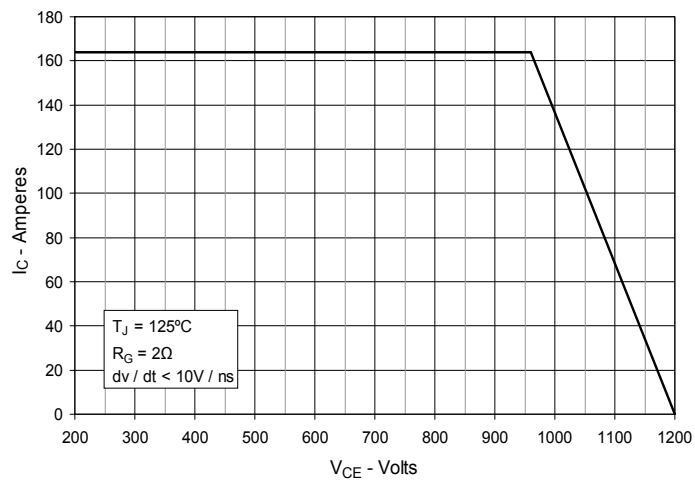
**Fig. 8. Gate Charge**



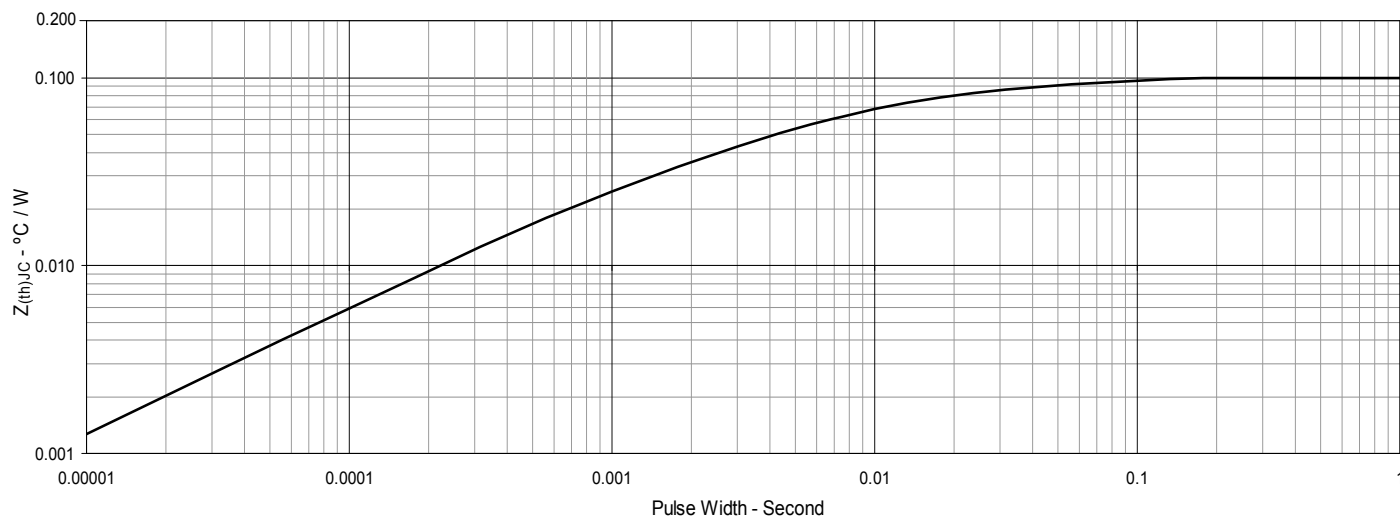
**Fig. 9. Capacitance**



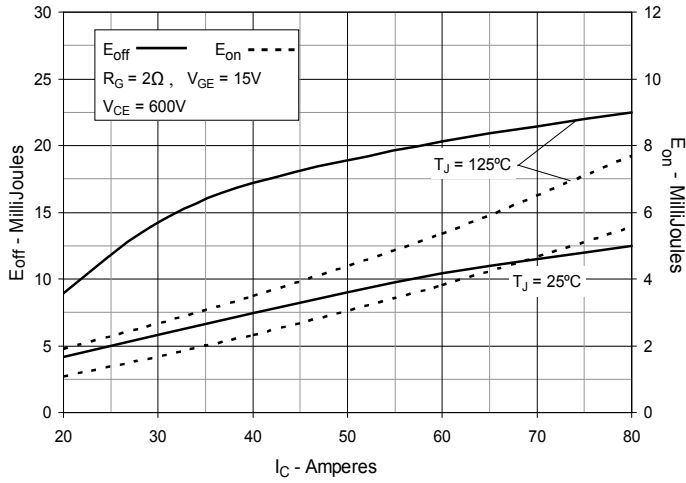
**Fig. 10. Reverse-Bias Safe Operating Area**



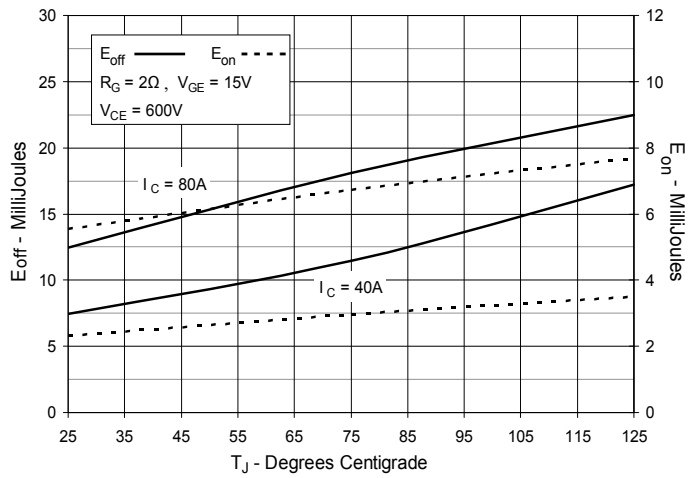
**Fig. 11. Maximum Transient Thermal Impedance**



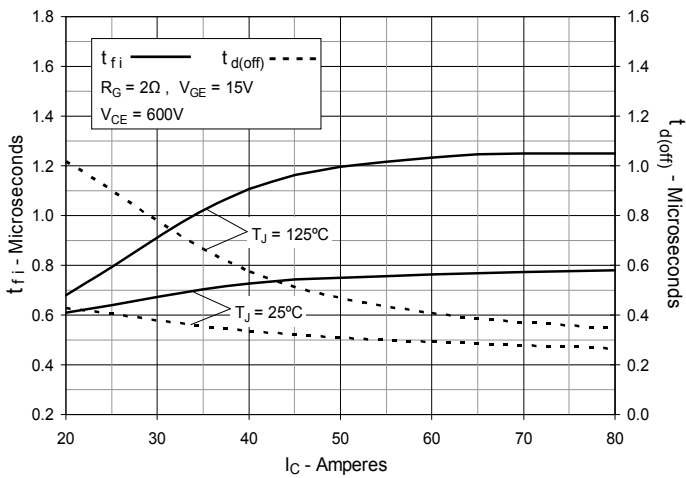
**Fig. 12. Inductive Switching  
Energy Loss vs. Collector Current**



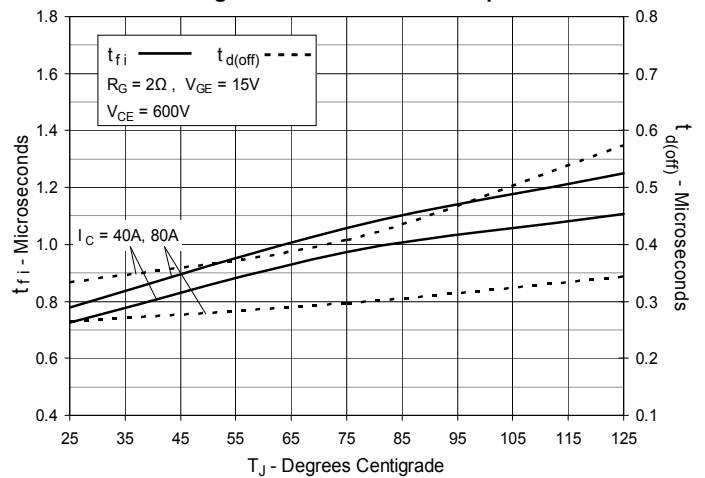
**Fig. 13. Inductive Switching  
Energy Loss vs. Junction Temperature**



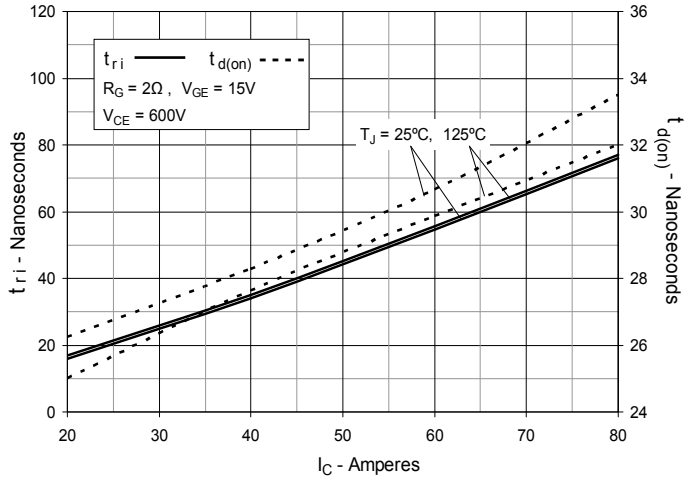
**Fig. 14. Inductive Turn-off  
Switching Times vs. Collector Current**



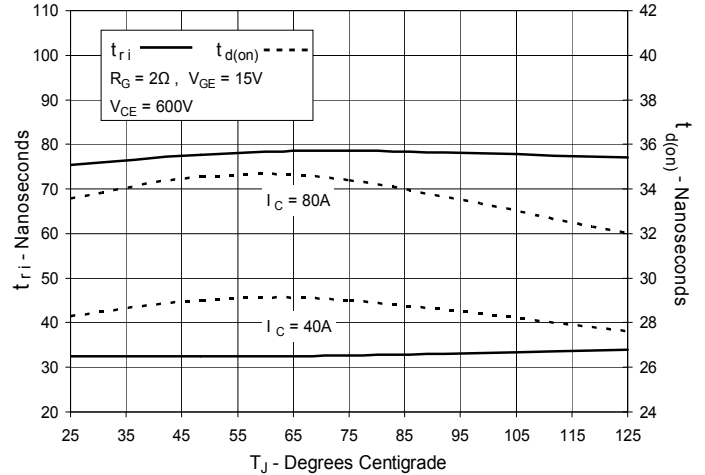
**Fig. 15. Inductive Turn-off  
Switching Times vs. Junction Temperature**



**Fig. 16. Inductive Turn-on  
Switching Times vs. Collector Current**



**Fig. 17. Inductive Turn-on  
Switching Times vs. Junction Temperature**





---

Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at [www.littelfuse.com/disclaimer-electronics](http://www.littelfuse.com/disclaimer-electronics).